

## E Series Power MOSFET

### PRODUCT SUMMARY

|                                         |                 |     |
|-----------------------------------------|-----------------|-----|
| $V_{DS}$ (V) at $T_J$ max.              | 700             |     |
| $R_{DS(on)}$ max. at 25 °C ( $\Omega$ ) | $V_{GS} = 10$ V | 0.6 |
| $Q_g$ max. (nC)                         | 48              |     |
| $Q_{gs}$ (nC)                           | 6               |     |
| $Q_{gd}$ (nC)                           | 11              |     |
| Configuration                           | Single          |     |

### FEATURES

- Low Figure-of-Merit (FOM)  $R_{on} \times Q_g$
- Low Input Capacitance ( $C_{iss}$ )
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge ( $Q_g$ )
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

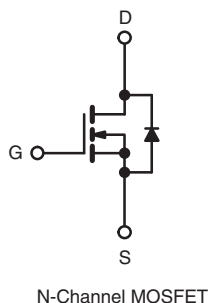
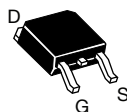


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
  - High-Intensity Discharge (HID)
  - Fluorescent Ballast Lighting
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
  - Battery Chargers
  - Renewable Energy
  - Solar (PV Inverters)

**DPAK  
(TO-252)**



### ORDERING INFORMATION

|                                 |               |
|---------------------------------|---------------|
| Package                         | DPAK (TO-252) |
| Lead (Pb)-free and Halogen-free | SiHD6N65E-GE3 |

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

| PARAMETER                                                 | SYMBOL         | LIMIT         | UNIT |
|-----------------------------------------------------------|----------------|---------------|------|
| Drain-Source Voltage                                      | $V_{DS}$       | 650           | V    |
| Gate-Source Voltage                                       | $V_{GS}$       | $\pm 20$      |      |
| Gate-Source Voltage AC ( $f > 1$ Hz)                      |                | 30            |      |
| Continuous Drain Current ( $T_J = 150$ °C)                | $I_D$          | 7             | A    |
|                                                           |                | 5             |      |
| Pulsed Drain Current <sup>a</sup>                         | $I_{DM}$       | 18            |      |
| Linear Derating Factor                                    |                | 0.63          | W/°C |
| Single Pulse Avalanche Energy <sup>b</sup>                | $E_{AS}$       | 56            | mJ   |
| Maximum Power Dissipation                                 | $P_D$          | 78            | W    |
| Operating Junction and Storage Temperature Range          | $T_J, T_{stg}$ | - 55 to + 150 | °C   |
| Drain-Source Voltage Slope                                | $dV/dt$        | 37            | V/ns |
| Reverse Diode $dV/dt$ <sup>d</sup>                        |                | 27            |      |
| Soldering Recommendations (Peak Temperature) <sup>c</sup> |                | 300           | °C   |

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$  V, starting  $T_J = 25$  °C,  $L = 28.2$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 2$  A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/ $\mu$ s, starting  $T_J = 25$  °C.

**THERMAL RESISTANCE RATINGS**

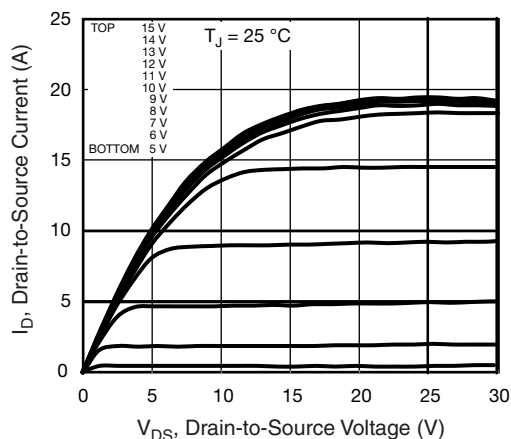
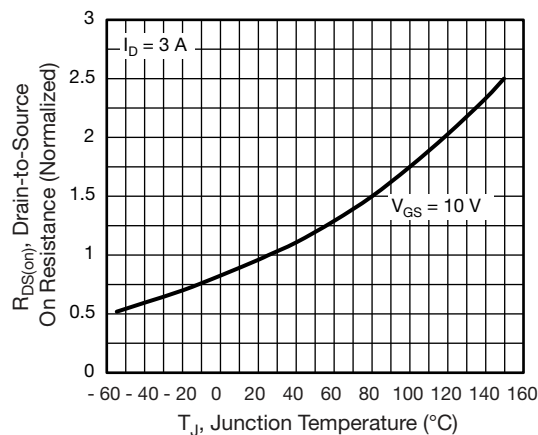
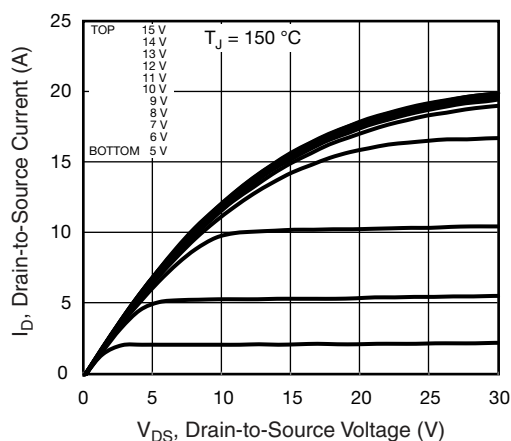
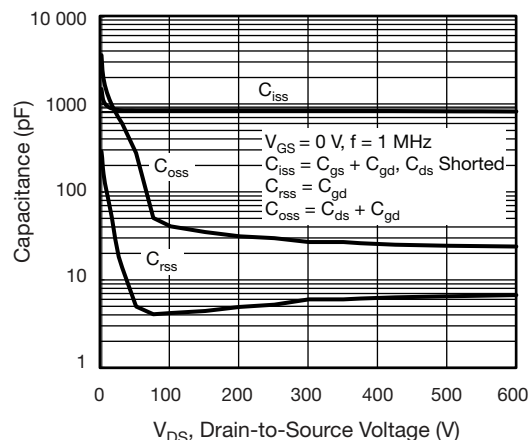
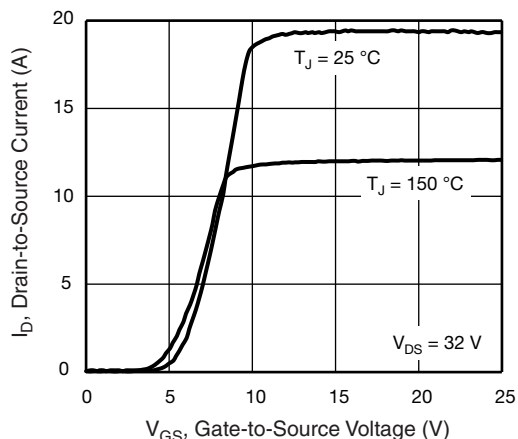
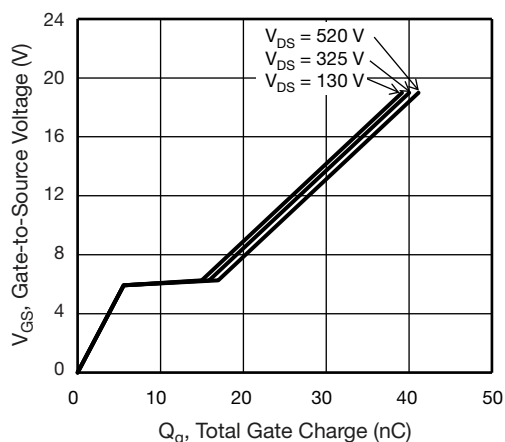
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT |
|----------------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient      | $R_{thJA}$ | -    | 62   | °C/W |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | -    | 1.6  |      |

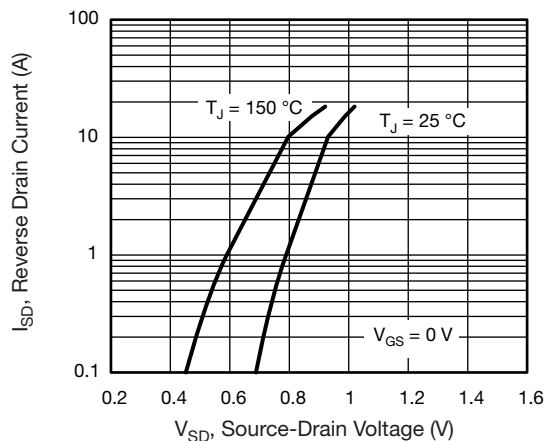
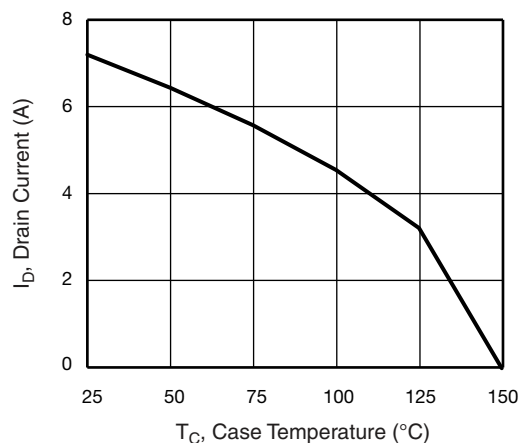
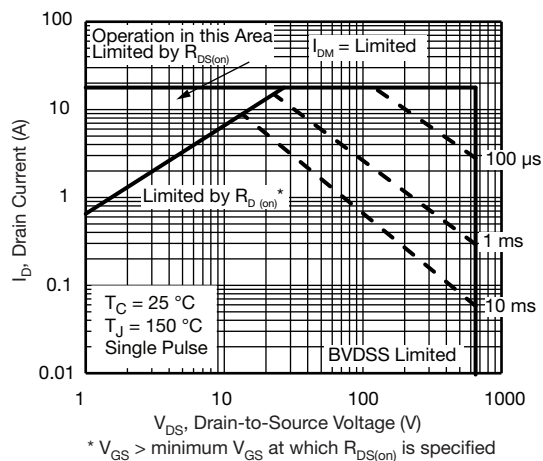
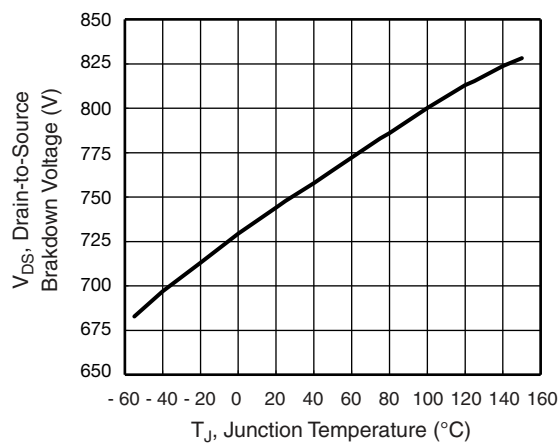
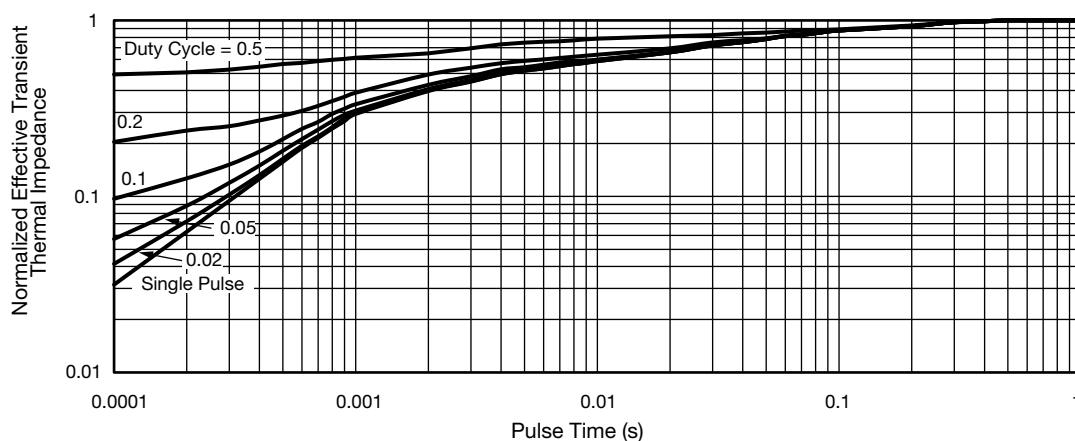
**SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

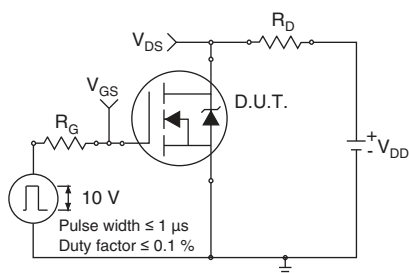
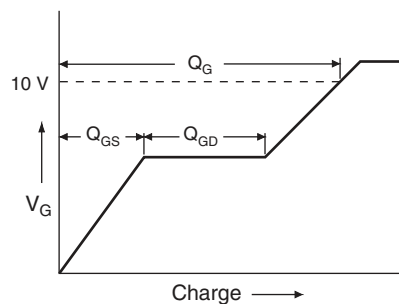
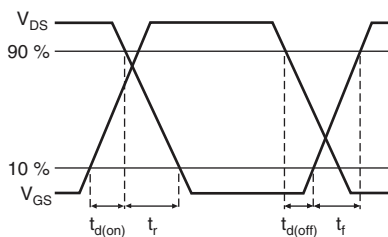
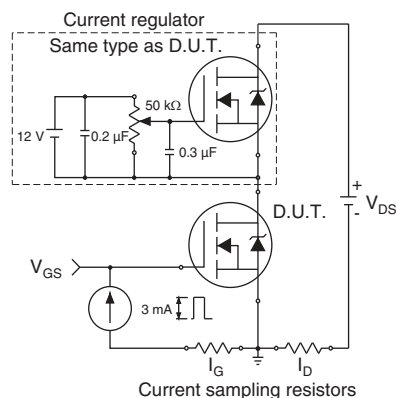
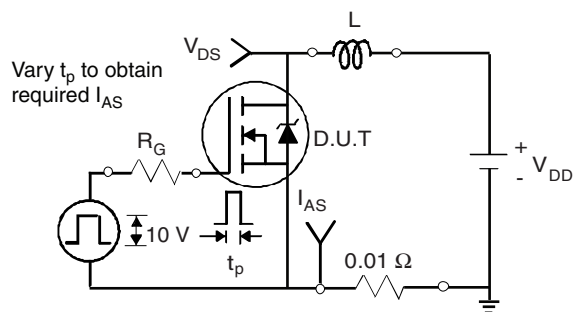
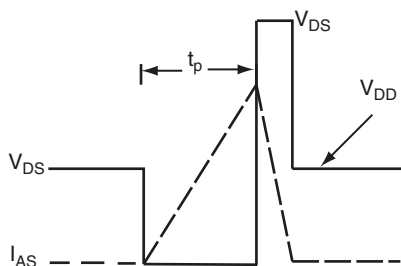
| PARAMETER                                                 | SYMBOL              | TEST CONDITIONS                                                                                                                                       | MIN. | TYP. | MAX.      | UNIT          |
|-----------------------------------------------------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|-----------|---------------|
| <b>Static</b>                                             |                     |                                                                                                                                                       |      |      |           |               |
| Drain-Source Breakdown Voltage                            | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                | 650  | -    | -         | V             |
| $V_{DS}$ Temperature Coefficient                          | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^{\circ}\text{C}$ , $I_D = 1\text{ mA}$                                                                                       | -    | 0.73 | -         | V/°C          |
| Gate-Source Threshold Voltage (N)                         | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                    | 2    | -    | 4         | V             |
| Gate-Source Leakage                                       | $I_{GSS}$           | $V_{GS} = \pm 20\text{ V}$                                                                                                                            | -    | -    | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current                           | $I_{DSS}$           | $V_{DS} = 650\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                                       | -    | -    | 1         | $\mu\text{A}$ |
|                                                           |                     | $V_{DS} = 520\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                                 | -    | -    | 10        |               |
| Drain-Source On-State Resistance                          | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$                                                                                                           | -    | 0.5  | 0.6       | $\Omega$      |
| Forward Transconductance                                  | $g_{fs}$            | $V_{DS} = 30\text{ V}$ , $I_D = 3\text{ A}$                                                                                                           | -    | 2    | -         | S             |
| <b>Dynamic</b>                                            |                     |                                                                                                                                                       |      |      |           |               |
| Input Capacitance                                         | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 100\text{ V}$ ,<br>$f = 1\text{ MHz}$                                                                            | -    | 820  | -         | pF            |
| Output Capacitance                                        | $C_{oss}$           |                                                                                                                                                       | -    | 40   | -         |               |
| Reverse Transfer Capacitance                              | $C_{rss}$           |                                                                                                                                                       | -    | 4    | -         |               |
| Effective Output Capacitance, Energy Related <sup>a</sup> | $C_{o(er)}$         | $V_{DS} = 0\text{ V to } 520\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                        | -    | 36   | -         |               |
| Effective Output Capacitance, Time Related <sup>b</sup>   | $C_{o(tr)}$         |                                                                                                                                                       | -    | 117  | -         |               |
| Total Gate Charge                                         | $Q_g$               | $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$ , $V_{DS} = 520\text{ V}$                                                                                 | -    | 24   | 48        | nC            |
| Gate-Source Charge                                        | $Q_{gs}$            |                                                                                                                                                       | -    | 6    | -         |               |
| Gate-Drain Charge                                         | $Q_{gd}$            |                                                                                                                                                       | -    | 11   | -         |               |
| Turn-On Delay Time                                        | $t_{d(on)}$         | $V_{DD} = 520\text{ V}$ , $I_D = 3\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$ , $R_g = 9.1\text{ }\Omega$                                                  | -    | 14   | 28        | ns            |
| Rise Time                                                 | $t_r$               |                                                                                                                                                       | -    | 12   | 24        |               |
| Turn-Off Delay Time                                       | $t_{d(off)}$        |                                                                                                                                                       | -    | 30   | 60        |               |
| Fall Time                                                 | $t_f$               |                                                                                                                                                       | -    | 20   | 40        |               |
| Gate Input Resistance                                     | $R_g$               | $f = 1\text{ MHz}$ , open drain                                                                                                                       | -    | 1.4  | -         | $\Omega$      |
| <b>Drain-Source Body Diode Characteristics</b>            |                     |                                                                                                                                                       |      |      |           |               |
| Continuous Source-Drain Diode Current                     | $I_S$               | MOSFET symbol showing the integral reverse p - n junction diode  | -    | -    | 7         | A             |
| Pulsed Diode Forward Current                              | $I_{SM}$            |                                                                                                                                                       | -    | -    | 18        |               |
| Diode Forward Voltage                                     | $V_{SD}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_S = 3\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                       | -    | -    | 1.3       | V             |
| Reverse Recovery Time                                     | $t_{rr}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_F = I_S = 3\text{ A}$ ,<br>$dI/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 25\text{ V}$                           | -    | 237  | -         | ns            |
| Reverse Recovery Charge                                   | $Q_{rr}$            |                                                                                                                                                       | -    | 2.2  | -         | $\mu\text{C}$ |
| Reverse Recovery Current                                  | $I_{RRM}$           |                                                                                                                                                       | -    | 16   | -         | A             |

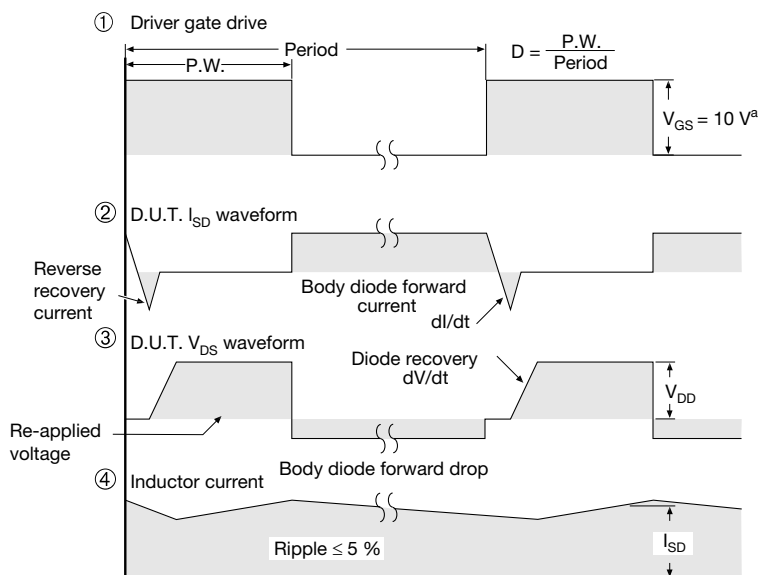
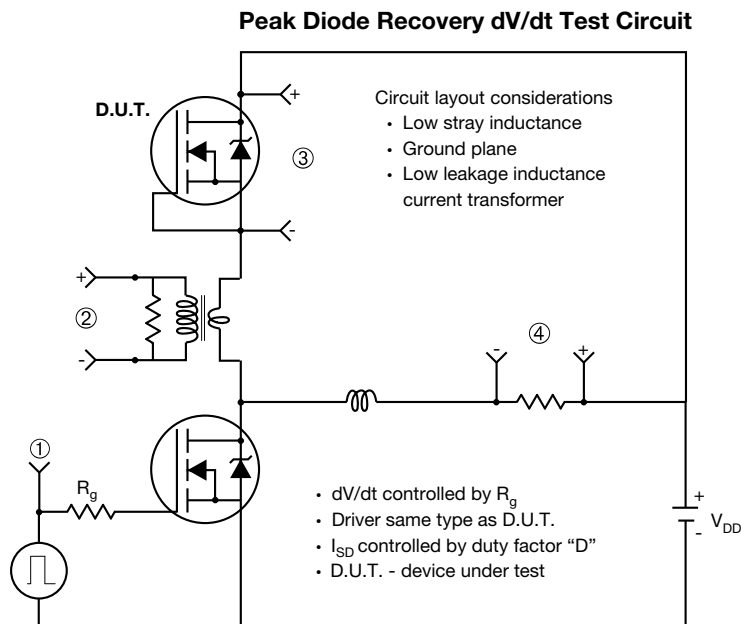
**Notes**

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .  
b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**


**Fig. 7 - Typical Source-Drain Diode Forward Voltage**

**Fig. 9 - Maximum Drain Current vs. Case Temperature**

**Fig. 8 - Maximum Safe Operating Area**

**Fig. 10 - Temperature vs. Drain-to-Source Voltage**

**Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case**


**Fig. 12 - Switching Time Test Circuit**

**Fig. 16 - Basic Gate Charge Waveform**

**Fig. 13 - Switching Time Waveforms**

**Fig. 17 - Gate Charge Test Circuit**

**Fig. 14 - Unclamped Inductive Test Circuit**

**Fig. 15 - Unclamped Inductive Waveforms**


**Note**

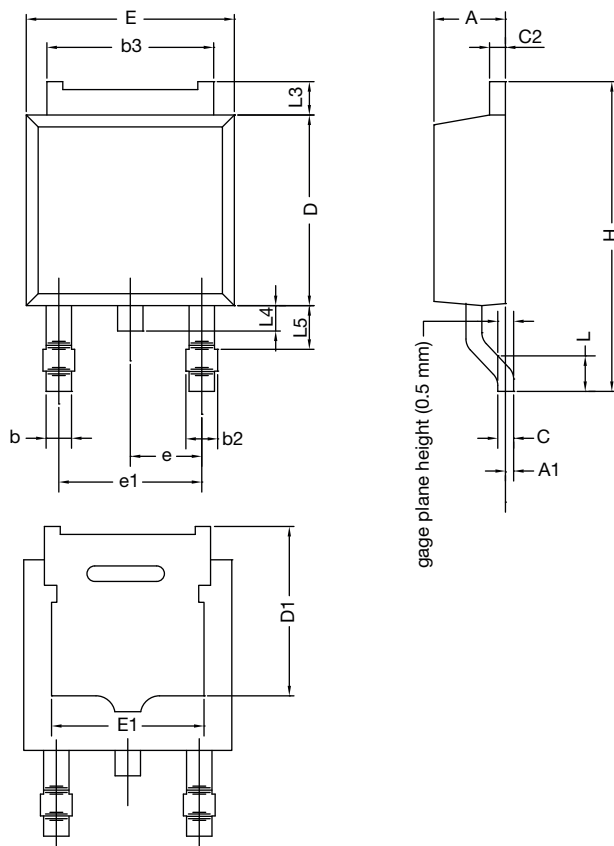
a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 18 - For N-Channel**

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## TO-252AA Case Outline

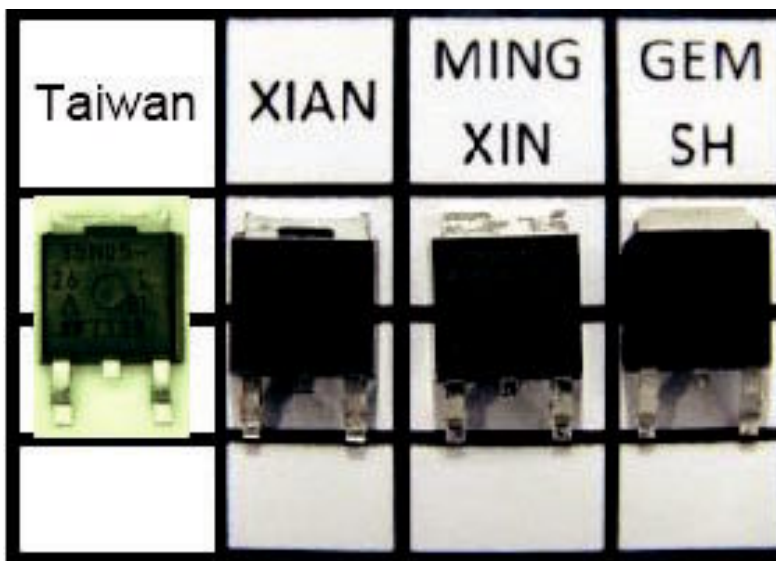


| DIM. | MILLIMETERS |       | INCHES    |       |
|------|-------------|-------|-----------|-------|
|      | MIN.        | MAX.  | MIN.      | MAX.  |
| A    | 2.18        | 2.38  | 0.086     | 0.094 |
| A1   | -           | 0.127 | -         | 0.005 |
| b    | 0.64        | 0.88  | 0.025     | 0.035 |
| b2   | 0.76        | 1.14  | 0.030     | 0.045 |
| b3   | 4.95        | 5.46  | 0.195     | 0.215 |
| C    | 0.46        | 0.61  | 0.018     | 0.024 |
| C2   | 0.46        | 0.89  | 0.018     | 0.035 |
| D    | 5.97        | 6.22  | 0.235     | 0.245 |
| D1   | 4.10        | -     | 0.161     | -     |
| E    | 6.35        | 6.73  | 0.250     | 0.265 |
| E1   | 4.32        | -     | 0.170     | -     |
| H    | 9.40        | 10.41 | 0.370     | 0.410 |
| e    | 2.28 BSC    |       | 0.090 BSC |       |
| e1   | 4.56 BSC    |       | 0.180 BSC |       |
| L    | 1.40        | 1.78  | 0.055     | 0.070 |
| L3   | 0.89        | 1.27  | 0.035     | 0.050 |
| L4   | -           | 1.02  | -         | 0.040 |
| L5   | 1.01        | 1.52  | 0.040     | 0.060 |

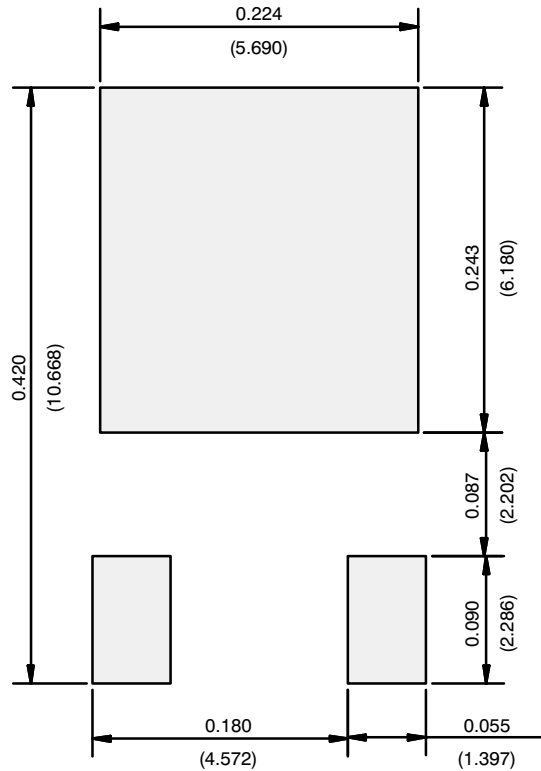
ECN: T13-0359-Rev. O, 03-Jun-13  
DWG: 5347

### Notes

- Dimension L3 is for reference only.
- Xi'an, Mingxin, and GEM SH actual photo.



## RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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**Стандарт  
Электрон  
Связь**

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